

Silicon diffused power transistors

BUX84; BUX85

High-voltage, high-speed, glass-passivated npn power transistors in TO-220 envelopes, intended for use in converters, inverters, switching regulators, motor control systems and switching applications.

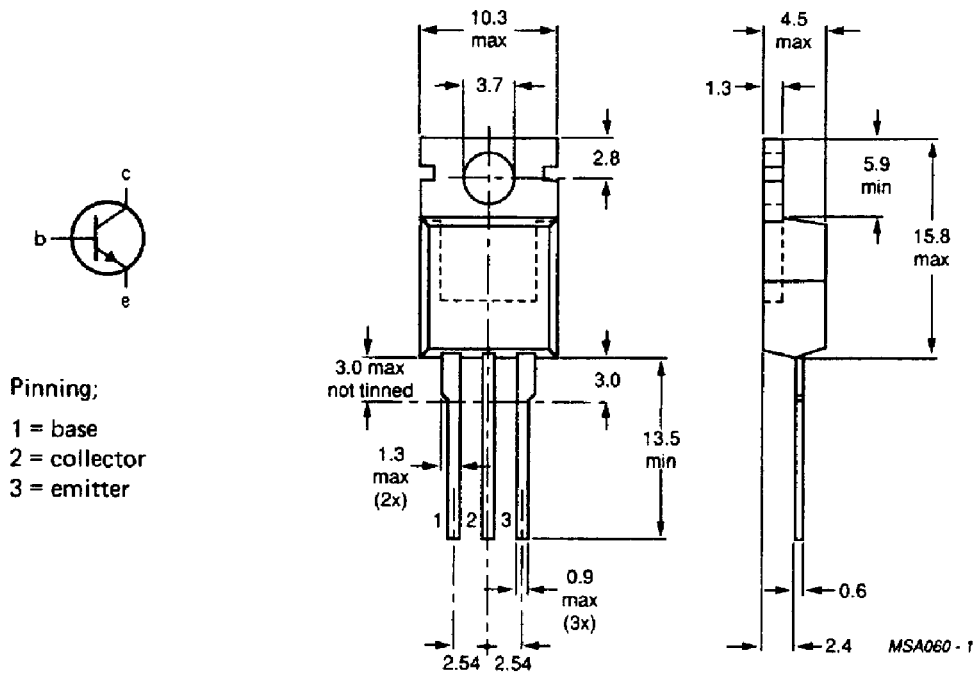
QUICK REFERENCE DATA

		BUX84	BUX85
Collector-emitter voltage (peak value; $V_{BE} = 0$ )	$V_{CESM}$ max.	800	1000 V
Collector-emitter voltage (open base)	$V_{CEO}$ max.	400	450 V
Collector-emitter saturation voltage	$V_{CEsat}$ max.	1	V
Collector current (DC)	$I_C$ max.	2	A
Collector current (peak value)	$I_{CM}$ max.	3	A
Total power dissipation up to $T_{mb} = 50\text{ }^\circ\text{C}$	$P_{tot}$ max.	40	W
Fall time	$t_f$ max.	0,4	$\mu\text{s}$

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-220AB.



Collector connected to tab

7110826 0077821 53T

December 1991

416

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**RATINGS** Limiting values in accordance with the Absolute Maximum System (IEC134)

		BUX84	BUX85	
Collector-emitter voltage (peak value; $V_{BE} = 0$ )	$V_{CESM}$	max 800	1000	V
Collector-emitter voltage (open base)	$V_{CEO}$	max 400	450	V
Collector current (DC)	$I_C$	max 2		A
Collector current (peak value) $t_p = 2$ ms	$I_{CM}$	max 3		A
Base current (DC)	$I_B$	max 0,75		A
Base current (peak value)	$I_{BM}$	max 1		A
Reverse base current (peak value) *	$-I_{BM}$	max 1		A
Total power dissipation up to $T_{mb} = 50$ °C	$P_{tot}$	max 40		W
Storage temperature range	$T_{stg}$	-65 to +150		°C
Junction temperature	$T_j$	max 150		°C

**THERMAL RESISTANCE**

From junction to mounting base	$R_{th\ j-mb}$	= 2,5		K/W
From junction to ambient in free air	$R_{th\ j-a}$	= 70		K/W

**CHARACTERISTICS**

$T_j = 25$  °C unless otherwise specified

**Collector cut-off current \*\***

$V_{CEM} = V_{CESMmax}; V_{BE} = 0$	$I_{CES}$	max. 200		$\mu$ A
$V_{CEM} = V_{CESMmax}; V_{BE} = 0; T_j = 125$ °C	$I_{CES}$	max. 1,5		mA

**DC current gain**

$I_C = 5$ mA; $V_{CE} = 5$ V	$h_{FE}$	min. 15		
$I_C = 100$ mA; $V_{CE} = 5$ V	$h_{FE}$	min. 20		
	$h_{FE}$	typ. 50		
	$h_{FE}$	max. 100		

\* Turn-off current.

\*\* Measured with a half-sinewave voltage (curve tracer).

7110826 0077822 476

December 1991

417

Silicon diffused power transistors

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Emitter cut-off current

$I_C = 0; V_{EB} = 5\text{ V}$	$I_{EBO}$	max.	1	mA
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Saturation voltages

$I_C = 0,3\text{ A}; I_B = 30\text{ mA}$	$V_{CEsat}$	max.	0,8	V
$I_C = 1\text{ A}; I_B = 0,2\text{ A}$	$V_{CEsat}$	max.	1,0	V
$I_C = 1\text{ A}; I_B = 0,2\text{ A}$	$V_{BEsat}$	max.	1,1	V

Collector-emitter sustaining voltage

$I_C = 100\text{ mA}; I_{Boff} = 0; L = 25\text{ mH}$	$V_{CEOsust}$	min.	<table border="1" style="display: inline-table; vertical-align: middle;"> <tr> <td>BUX84</td> <td>BUX85</td> </tr> <tr> <td>400</td> <td>450</td> </tr> </table>	BUX84	BUX85	400	450	V
BUX84	BUX85							
400	450							

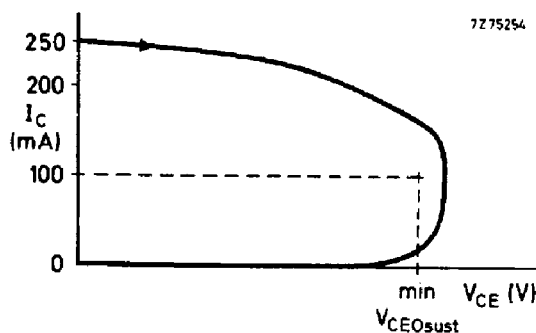


Fig. 2 Oscilloscope display for sustaining voltage.

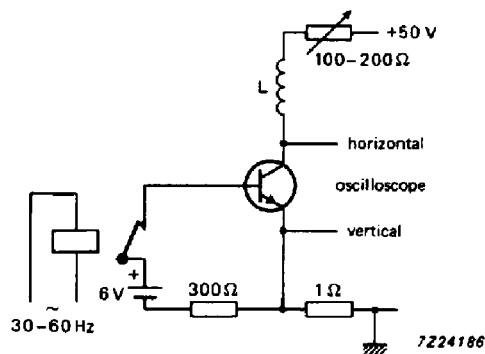


Fig. 3 Test circuit for  $V_{CEOsust}$ .

7110826 0077823 302

December 1991

418

Silicon diffused power transistors

BUX84; BUX85

CHARACTERISTICS (continued)

$T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified

Transition frequency at  $f = 1\text{ MHz}$

$I_C = 0,2\text{ A}$ ;  $V_{CE} = 10\text{ V}$

$f_T$  typ 20 MHz

Switching times

$I_{Con} = 1\text{ A}$ ;  $V_{CC} = 250\text{ V}$

$I_{Bon} = 0,2\text{ A}$ ;  $-I_{Boff} = 0,4\text{ A}$

Turn-on time

$t_{on}$  typ 0,2  $\mu\text{s}$   
max. 0,5  $\mu\text{s}$

Turn-off: Storage time

$t_s$  typ 2  $\mu\text{s}$   
max. 3,5  $\mu\text{s}$

Fall time

$t_f$  typ 0,4  $\mu\text{s}$

Fall time,  $T_{mb} = 95\text{ }^\circ\text{C}$

$t_f$  max. 1,4  $\mu\text{s}$

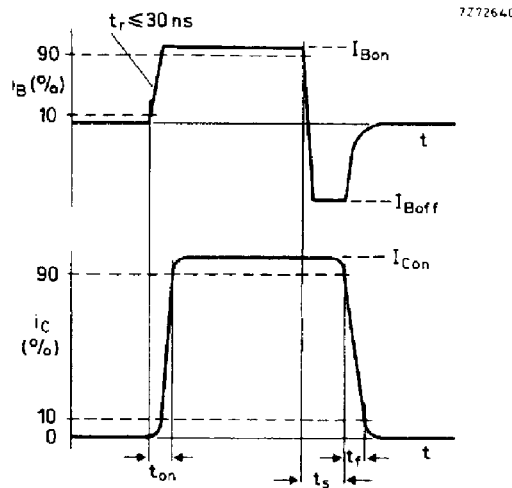


Fig. 4 Switching times waveforms with resistive load.

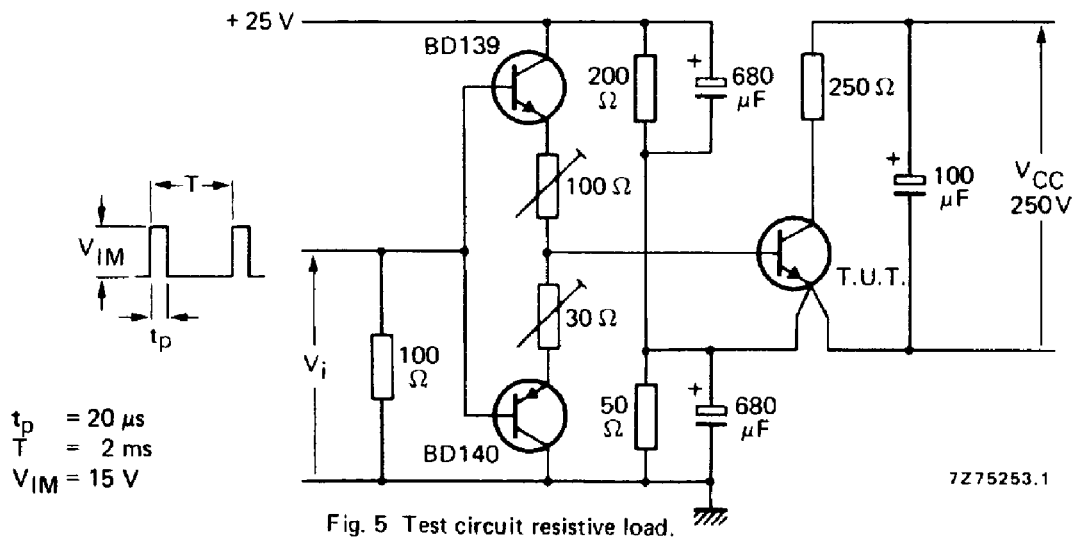


Fig. 5 Test circuit resistive load.

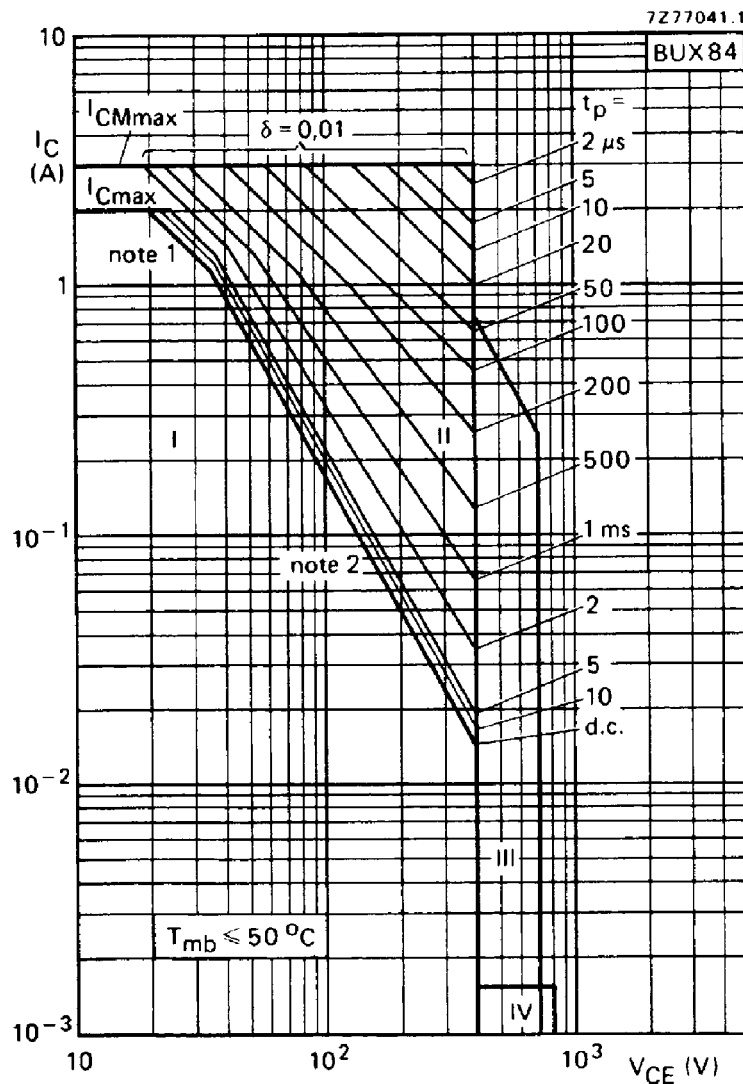
7110826 0077824 249

December 1991

419

Silicon diffused power transistors

BUX84; BUX85



1.  $P_{tot\ max}$  and  $P_{peak\ max}$  lines.
2. Second-breakdown limits.

- I Region of permissible DC operation
- II Permissible extension for repetitive pulse operation
- III Area of permissible operation during turn-on in single transistor converters, provided  $R_{BE} \leq 100\ \Omega$  and  $t_p \leq 0,6\ \mu s$
- IV Repetitive pulse operation in this region is permissible, provided  $V_{BE} \leq 0$  and  $t_p \leq 2\ ms$

Fig. 6 Safe operating area.

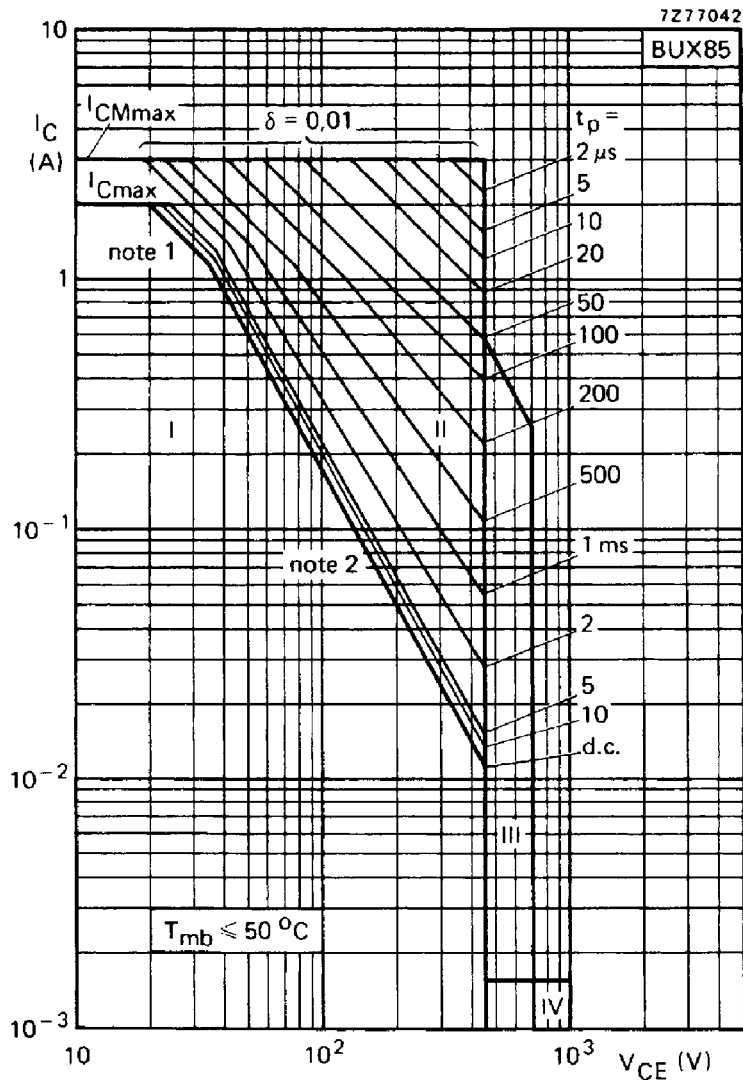
7110826 0077825 185

December 1991

420

Silicon diffused power transistors

BUX84; BUX85



1.  $P_{tot\ max}$  and  $P_{peak\ max}$  lines.
  2. Second-breakdown limits.
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Fig. 7 Safe operating area.

7110826 0077826 011

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BUX84; BUX85

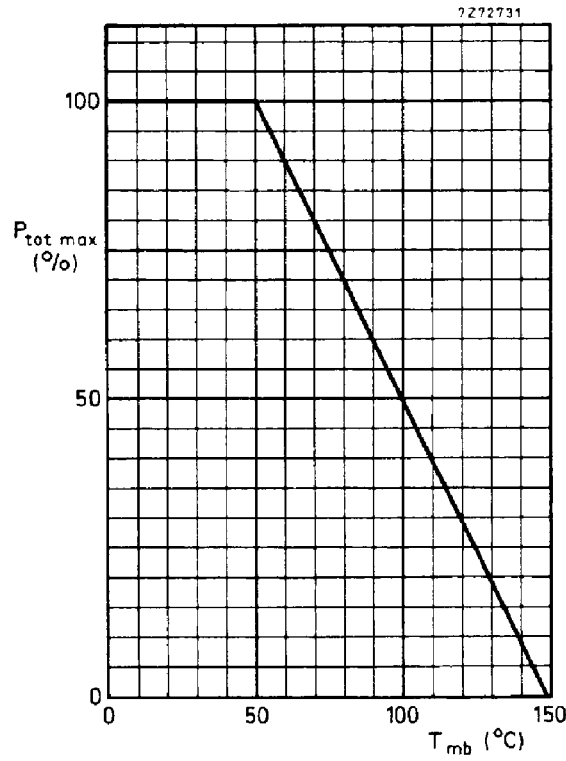


Fig. 8 Power derating curve.

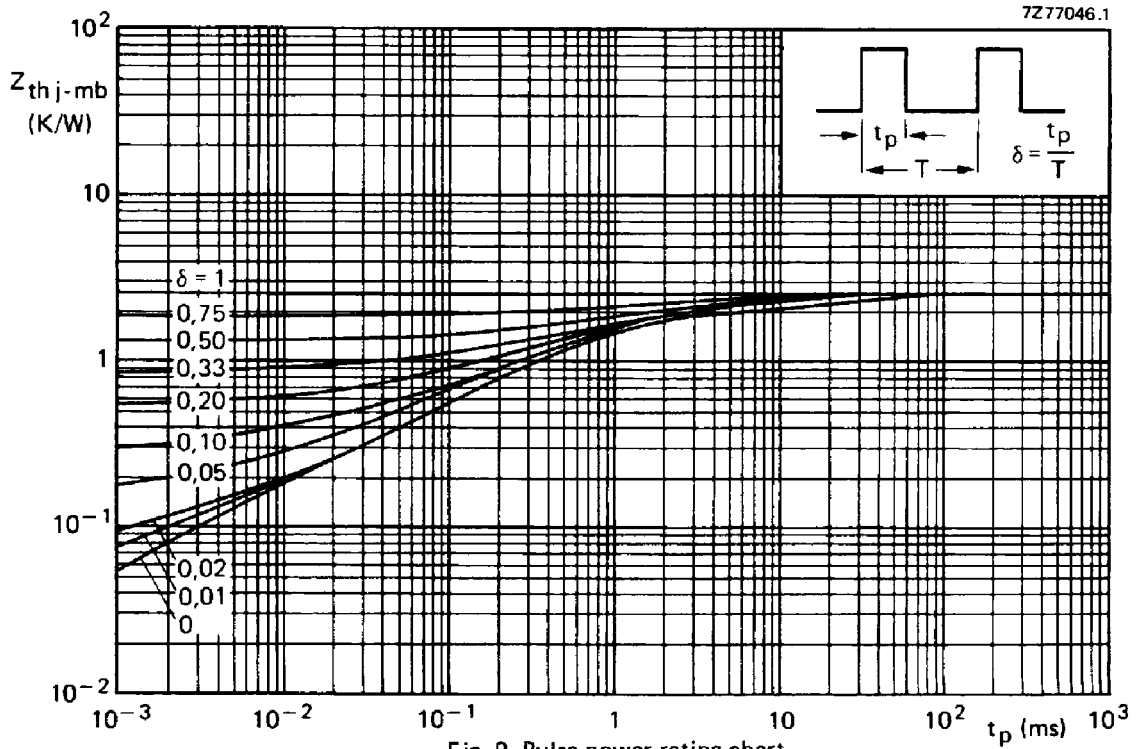


Fig. 9 Pulse power rating chart.

7110826 0077827 T58

December 1991

422

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BUX84; BUX85

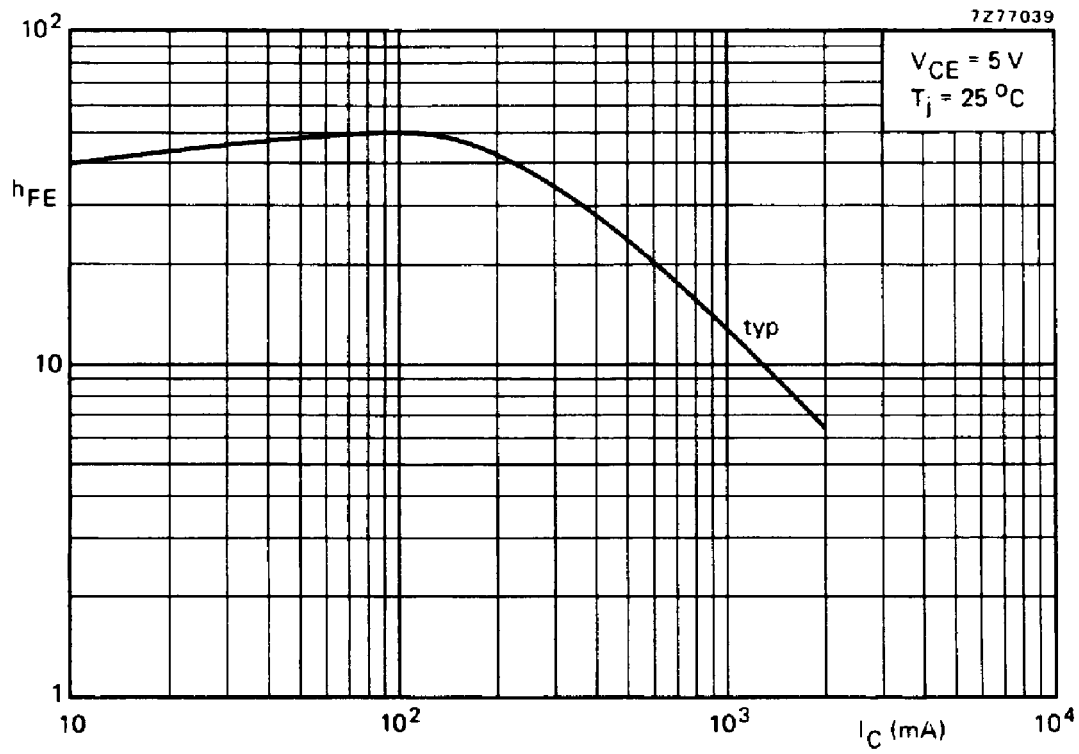


Fig. 10 Typical DC current gain.

7110826 0077828 994

December 1991

423



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BUX84; BUX85

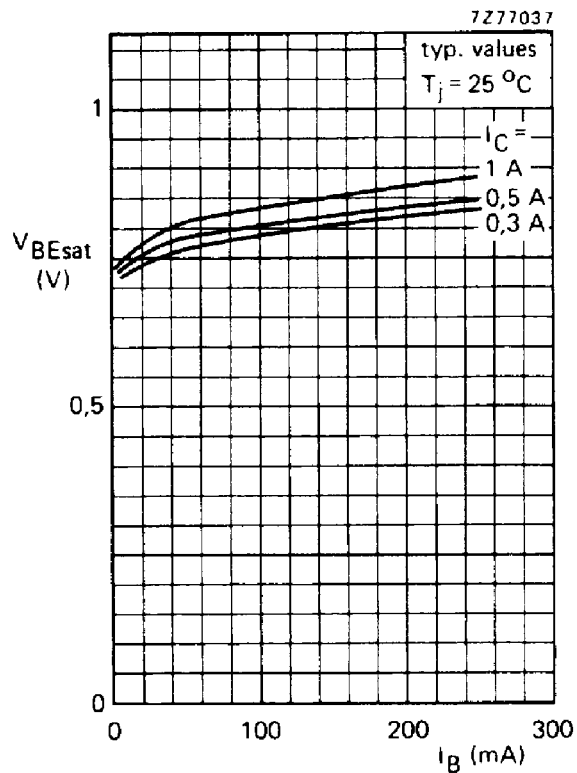


Fig. 11 Typical values saturation voltage,  $T_j = 25\text{ }^\circ\text{C}$ .

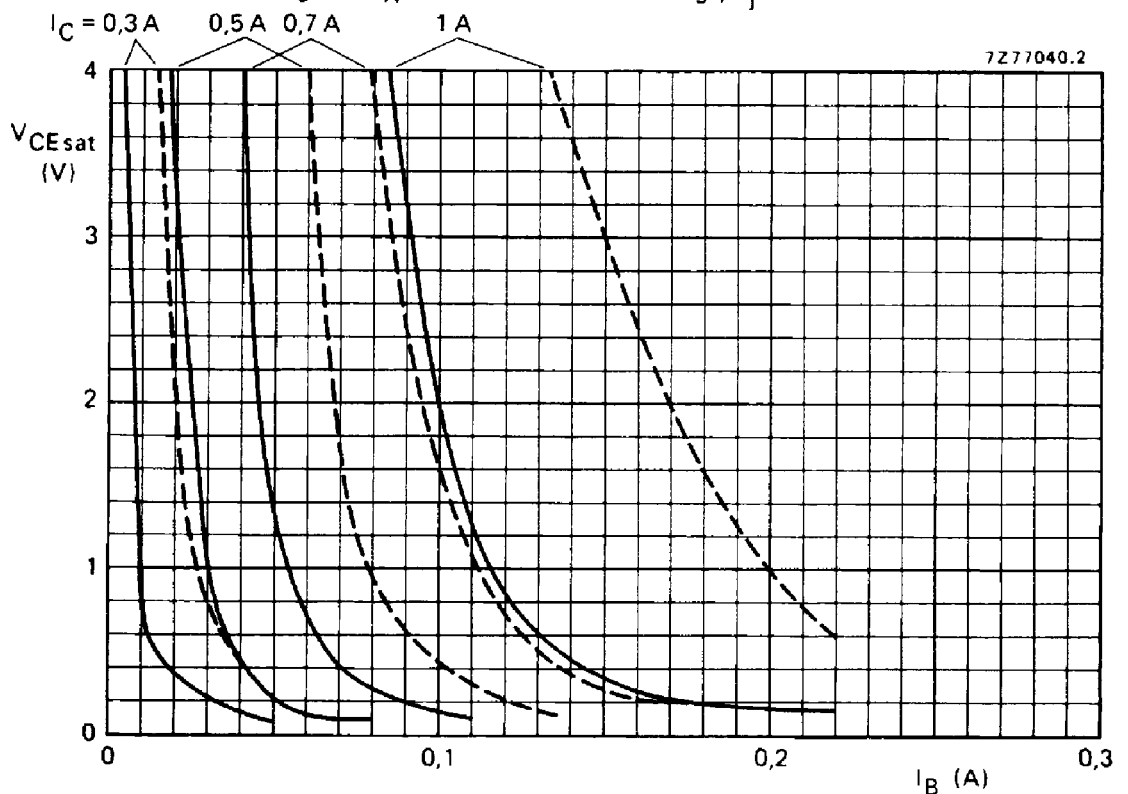


Fig. 12 Typical (—) and maximum (---) values saturation voltage at  $T_j = 25\text{ }^\circ\text{C}$ .

7110826 0077829 820  
December 1991